Notable items from MAC meeting (1)



- There will be a design change for one partials!
 - Hard geometry clash at cassette-level
 - Design file changes will be announced "soon™"
 - It has been requested that such changes be announced globally, so hopefully we get this announcement soon.



IHEP claiming that 3 (out of 14) plates in the November shipment **did not pass** hole dimension checks

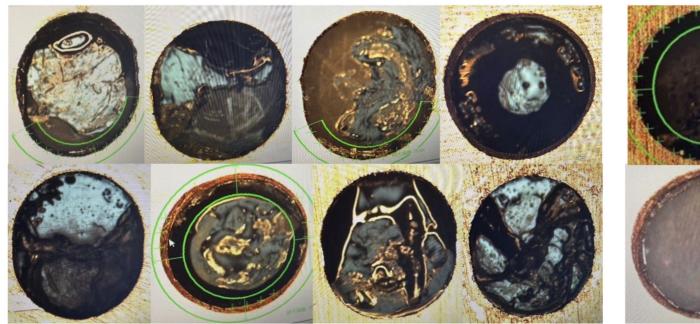
- CuW-LD-Full-00019 (passed on our side)
- CuW-LD-Full-00131 (NO DATA)
- CuW-LD-Full-00126 (passed on our side)

They are doing CV measurements, we are performing mechanical tests. Which do we trust more?? (They did attempt to place this on their assembly jig, are we able to get this jig?)

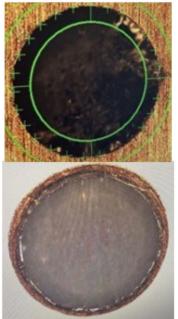
Notable items from MAC meeting (3)



Non-clean plates might be the only culprit for plates not fitting on their jig. Offending plates still uses **Hybrid** method, I think whay they are seeing is incomplete cleaning of residual glue tape. Do they still see this problem with the new full glue method? **KIT Baseplates**



IHEP Baseplates



All photos taken by OGP



?????

TTU is reporting that the holes are **too large**? Some numbers are a bit of a mystery....

They have only measured 3 plates out of 8.

(mm)	CuW_18	CuW_30	CuW_37	Specifications
	167.061	167.013	167.064	
Flat-to-Flat	167.078	167.064	167.070	166.74+/- 0.1
?????	167.046	167.042	167.066	
Hole Dia	3.357	3.355	3.347	3.050±0.025
Hole Depth	1.467	1.525	1.444	
Slot X	3.137	3.061	3.080	3.050±0.025
Slot Y	3.619	3.557	3.565	3.55
Slot Depth	1.457	1.450	1.418	
Thickness	1.83	1.71	1.71	1.77+/- 0.1
Elatnoce	0.301	0.255	0.214	

More measurement feedback from IHEP and TTU has been requested.

Notable items from MAC meeting (5)



- NTU does not know what the 3 full glue plates were for...
 - Our notes made on November:

"send 3 full CuW plates to NTU laminated using the full glue procedure so that they can perform an **epoxy-only** test."

• UCSB commented the plan is the same as our notes, but the instructions were not passed to NTU...

Notable items from MAC meeting (6)



6

- Expected **Jan+Feb** shipments:
 - 20 Ti LD Full → Limited by metal availability (can provide 10)
 - 18 CuW LD Full \rightarrow (!) Close to depleting top glue plate
 - 63 CuW HD Full
 - *5 CuW HD Bottom (NTU radiation test)

At the production rate of **30-40** per week, we can complete this order by **Jan 17th** if we have full production capacity immediately on Jan 6th (I will be back then, but lamination is currently a 2 person job)

We can start building backlog of materials next year!



Attempting some recovery on some plates (to see requirements on personnel efforts)

- Soak assembly in Isopropanol (24 hr)
- Attempt to remove kapton (Destructive)
- Soak contaminated base plate in isopropanol (24 hr)
- Attempt to clean residual glue.





Attempting some recovery on some plates (to see requirements on personnel efforts)

- Soak assembly in Isopropanol (24 hr)
- Attempt to remove kapton (Destructive)
- Soak contaminated base plate in isopropanol (24 hr)
- Attempt to clean residual glue.

Kapton will NOT survive removal process This step still takes "a lot" of force. So adhesion is good!

Large glue deposits become hand-peelable "flakes"





Attempting some recovery on some plates (to see requirements on personnel efforts)

- Soak assembly in Isopropanol (24 hr)
- Attempt to remove kapton (Destructive)
- Soak contaminated base plate in isopropanol (24 hr)
- Attempt to clean residual glue "films" (this step is very hard...).





- END-OF-YEAR clean up!
 - Fully stick-clean of all surfaces.
 - All disposible personnel items will be discarded:
 - Hair net
 - Shoe guards
 - Entrance stick matt



- Discussion with NTU MAC
- Documentation
 - All in-lab equipment usage steps
 - Production pipeline formalizing (how many people do what)
- Lamination Jigs v2:
 - What is required? (Getting inspiration from NTU)
 - Vaccum hole layout for partials and their Kapton/gluetape.
- Purchase files for all top glue tapes

(Amount target is to our bare kapton inventory)



I will be visiting the NTU MAC during the holidays!

- Aggregating questions to ask MAC managers and **operators!**
- **HD-hexaboard** had a misassembly (wrong LDO resistor value, both for NTU and UCSB), all boards are sent back to manufacturer for correction. Likely no live assembly when I am in Taiwan : (
 - I will still ask to see where the baseplate will go and what checks will be performed on the MAC side.
 - They graciously delayed a HD bottom assembly so I can see assembly in person!